

1



## NASA Electronic Parts & Packaging (NEPP) Program

Peter Majewicz, Manager NEPP Program peter.majewicz@nasa.gov Jonny Pellish, Dep Manager, NEPP Program jonathan.pellish@nasa.gov

NASA/GSFC

NASA/GSFC

Michael J. Sampson, Manager, NEPAG, michael.j.sampson@nasa.gov NASA/GSFC

http://nepp.nasa.gov





# Acronyms

Abbreviation	Definition	Abbreviation	Definition
ABBIEVIATION	Air Force	NASA	National Aeronautics and Space Administration
BGA	Ball Grid Array	NEPAG	NASA Electronic Parts Assurance Group
BN	Bavesian Network	NEPP	NASA Electronic Parts and Packaging (Program)
Bok	Body of Knowledge	NESC	NASA Engineering and Safety Center
CMOS	Complementary Metal Oxide Semiconductor	NODIS	NASA Online Directives Information System
COTS	Commercial Off the Shelf	NPR	NASA Procedural Requirement
CPU	Central Processing Unit	NRO	National Reconnaissance Office
	Double Data Bate	NSREC	Nuclear and Space Badiation Effects Conference
DIA	Defense Logistics Agency	OCE	Office of the Chief Engineer
DMEA	Defense Microelectronics Activity	OGA	Other Government Agency
DoD	Department of Defense	DIC	Photonic Integrated Circuit
DoE	Department of Energy	POC	Point of Contact
FFF	Electrical Electronic and Electromechanical	POC	Physics of Failure
	Electronics Technology Workshop	PE	Padio Frequency
EPGA	Field Programmable Gate Array		Padiation Hardened
GaN	Gallium Nitride		Padiation Hardness Assurance
GIDER	Government Industry Data Exchange Program	SADD	Space Asset Protection Program
GPU	Granbics Processing Unit	SDRAM	Synchronous Dynamic Bandom Access Memory
GRC	Glenn Research Center	SEE	Single-Event Effects
GSEC	Goddard Space Elight Center	SIC	Silicon Carbide
GSN	Goal Structuring Notation	SMA	Safety and Mission Assurance
HO	Headquarters	SMC	Share and Missile Systems Center
	Integrated Circuit	SOA	Safe Operating Area
IFFF	Institute of Electrical and Electronics Engineers	SoC	System on a Chin
IDI	let Propulsion Laboratory	SRAM	Static Bandom Access Memory
ISC	Johnson Space Center	SCAI	Science Systems and Applications Inc
13C	Jonnson Space Center	STMD	Space Technology Mission Directorate
	Langley Research Center	STT	Spin Transfer Torque
	Military and Aerospace Programmable Logic Devices (Workshop)	SvcMI	System Modeling Language
MRMA	Model-Based Mission Assurance		
MRAM	Magnetic Random Access Memory	TSV	Thru-Silicon Via
MSEC	Mashall Shace Flight Center	150	





## NEPP Overview – Mission Statement

Provide NASA's leadership for developing and maintaining guidance for the screening, qualification, test, and reliable use of EEE parts by NASA, in collaboration with other government agencies and industry.

> NASA Electronic Parts Assurance Group (NEPAG) is a core portion of NEPP







# NEPP Program Charter Breakdown



To be presented at the Microelectronics Reliability and Qualification Workshop (MRQW), El Segundo, CA, February 4-6, 2020.





# **KEY FOCUS POINTS**



#### TELECONFERENCES NEPAG

- Weekly Domestic
- Monthly International

#### **Government Working Group**

- Biweekly

#### **Other specialty areas**

- Hybrids
- 2.5 & 3D Packaging
- Small Mission Success

#### SUPPORT DEFENSE STANDARDIZATION PROGRAM / DEFENSE LOGISTICS AGENCY (DLA)

- DLA audits
- Review MILSPEC Changes
- Attend JEDEC and SAE WG meetings
  - Class Y, PEMS, PEDS incorporation into MIL SPECS





## **GWG** *Government Working Group*

- **Purpose:** To discuss in detail topics from NEPAG that require additional in-depth technical solutions
- **Objective:** To establish a single government position applicable to both terrestrial and space programs
- Attendees: 7 Government User Agencies and DLA

Air Force – SMC/The Aerospace Corporation; Air Force – Wright-Patterson; Army; MDA; NASA Centers; Navy – NSWC Crane Division; NRO/The Aerospace Corporation

#### Specifications & Standards Review



MIL-STD-1580 DPA MIL-PRF-38534 Hybrids MIL-PRF-55342 Resistors MIL-PRF-123 Capacitors

#### **Mission Assurance Efforts**



Provided analysis against an optimization effort that had potential to jeopardize package integrity.

#### Continuous Improvement Efforts



Support JEDEC task groups on issues including PIND enhancement study, copper wire bonds,

To be presented at the Microelectronics Reliability and Qualification Workshop (MRQW), El Segundo, CA, February 4-6, 2020.





# Standards & Policy Development

## Updating NPR-8705.4, Risk Classification for NASA Payloads

- Appendix D Recommended SMA-Related Program Requirements for NASA Class A-D Payloads
- Contains a mapping for EEE Parts that recommends parts with respect to payload class (A-D), mission criticality (critical/noncritical) to part grade level (space, military, industrial, COTS, etc.)

## Updating EEE-INST-002, Instructions for EEE Parts Selection, Screening, Qualification, and Derating

- Original:
  - GSFC document (used by other Centers)
  - 3 Quality Levels
  - 18 Device Specific Sections
  - Last update 2003

- Update
  - 4 Quality Levels
  - Lot Acceptance Testing
  - Plan is 29 Device Specific Sections
  - Completion in CY20



# Radiation Work









# Hubble Telescope Turns 30 This Year!















To be presented at the Microelectronics Reliability and Qualification Workshop (MRQW), El Segundo, CA, February 4-6, 2020.





# Mars 2020 Rover



#### July 2020 Launch



The launch period for the **Mars 2020** mission opens on July 17, **2020**. After the spacecraft lands on the **Martian** surface on Feb. 18, 2021, the rover will search for signs of past microbial life, characterize the planet's climate and geology, and collect samples.







Emerging Assurance Methods (Witulski, Vanderbilt University, NEPP ETW 2017)

Image credit: Vanderbilt / NASA



Advanced Technology Reliability

## 11<sup>th</sup> Annual NEPP Electronics Technology Workshop (ETW)

Scheduled dates: June 15-18, 2020 NASA/GSFC and on-line

https://nepp.nasa.gov/



Radiation Testing



Commercial IC Packaging





# **Questions?**



# Artemis



# Lunar Exploration Program

- Working with U.S. companies and international partners, NASA will push the boundaries of human exploration forward to the Moon and on to Mars.
- NASA is working to establish a *permanent human presence on the Moon within the next decade* to uncover new scientific discoveries and lay the foundation for private companies to build a lunar economy.
  - Groundbreaking Science
  - Surface Exploration
  - Lunar Outpost
  - Getting There: SLS and Orion
  - Looking to Mars



Space Launch System rocket & Orion capsule



Gateway – Power & Propulsion Element



#### Human Landing System

#### https://www.nasa.gov/mission\_pages/webb



- JWST or Webb) will be a large infrared telescope with a 6.5-meter primary mirror.
- The telescope will be launched on an Ariane 5 rocket from French Guiana in 2021.



Webb is an international collaboration between NASA, the European Space Agency (ESA), the Japanese Space Exploration Agency (JAXA), and the Space Agency (CSA).



Oct 2019: Deployed and tensioned the sunshield using spacecraft electronics





14